

(12) INTERNATIONAL APPLICATION PUBLISHED UNDER THE PATENT COOPERATION TREATY (PCT)

(19) World Intellectual Property Organization International Bureau



(43) International Publication Date
18 August 2005 (18.08.2005)

PCT

(10) International Publication Number
WO 2005/076264 A1

(51) International Patent Classification⁷: G11B 7/125,
H01S 5/026

AT, AU, AZ, BA, BB, BG, BR, BW, BY, BZ, CA, CH, CN,
CO, CR, CU, CZ, DE, DK, DM, DZ, EC, EE, EG, ES, FI,
GB, GD, GE, GH, GM, HR, HU, ID, IL, IN, IS, JP, KE,
KG, KP, KR, KZ, LC, LK, LR, LS, LT, LU, LV, MA, MD,
MG, MK, MN, MW, MX, MZ, NA, NI, NO, NZ, OM, PG,
PH, PL, PT, RO, RU, SC, SD, SE, SG, SK, SL, SY, TJ, TM,
TN, TR, TT, TZ, UA, UG, US, UZ, VC, VN, YU, ZA, ZM,
ZW.

(21) International Application Number:
PCT/IB2005/050255

(22) International Filing Date: 21 January 2005 (21.01.2005)

(25) Filing Language: English

(26) Publication Language: English

(30) Priority Data:
04100431.8 5 February 2004 (05.02.2004) EP

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(81) Designated States (unless otherwise indicated, for every kind of national protection available): AE, AG, AL, AM,

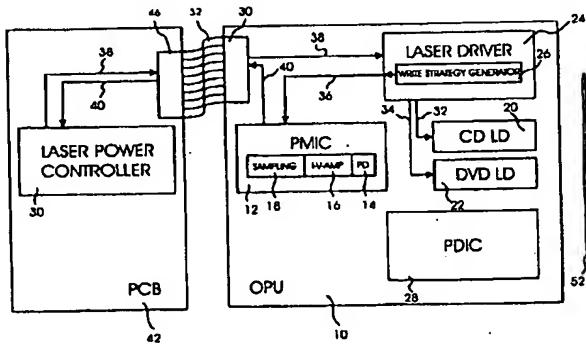
(84) Designated States (unless otherwise indicated, for every kind of regional protection available): ARIP (BW, GH, GM, KE, LS, MW, MZ, NA, SD, SL, SZ, TZ, UG, ZM, ZW), Eurasian (AM, AZ, BY, KG, KZ, MD, RU, TJ, TM), European (AT, BE, BG, CH, CY, CZ, DE, DK, DZ, EC, EE, EG, ES, FI, GB, GR, HU, IE, IS, IT, LT, LU, MC, NL, PL, PT, RO, SE, SI, SK, TR), OAPI (BF, BJ, CF, CG, CI, CM, GA, GN, GQ, GW, ML, MR, NE, SN, TD, TG).

Declaration under Rule 4.17:

— as to applicant's entitlement to apply for and be granted a patent (Rule 4.17(ii)) for the following designations AE, AG, AL, AM, AT, AU, AZ, BA, BB, BG, BR, BW, BY, BZ, CA, CH, CN, CO, CR, CU, CZ, DE, DK, DM, DZ, EC, EE, EG, ES, FI, GB, GD, GE, GH, GM, HR, HU, ID, IL, IN, IS, JP, KE, KG, KP, KR, KZ, LC, LK, LR, LS, LT, LU, LV, MA, MD, MG, MK, MN, MW, MX, MZ, NA, NI, NO, NZ, OM.

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(54) Title: INTEGRATED PHOTO MONITOR CIRCUIT AND OPTICAL PICKUP UNIT



WO 2005/076264 A1

(57) **Abstract:** The invention provides an integrated photo monitor circuit (12), particularly an integrated photo monitor circuit (12) for CD and DVD applications, comprising a photo detector (14), an amplifier (16) for amplifying an output signal of said photo detector (14), and sampling circuitry (18) for sampling an output signal of said amplifier (16). The invention further provides an optical pickup unit (10), particularly an optical pickup unit (10) for CD and DVD applications, comprising means (20, 22) for emitting light, and means (12) for generating a sampled feedback signal (40) correlated to the output power of said means (20, 22) for emitting light and intended to be evaluated for controlling said output power of said means (20, 22) for emitting light. By providing the sampling function on the optical pickup unit (10), especially in an integrated photo monitoring circuit (12), the necessary bandwidth of a flex connection (32) between the optical pickup unit (10) and a printed circuit board (42) may be reduced compared to solutions where the sampling is done on the printed circuit board (42).